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(54) Title: DUAL DAMASCENE VIA FILLING COMPOSITION

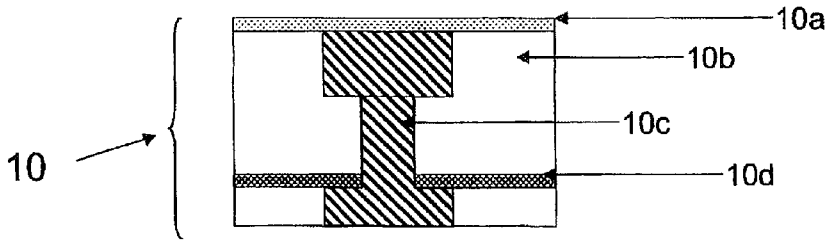


Fig. 1

(57) Abstract: Compositions for use in dual damascene process are disclosed.